Lead-free Green

## Product Summary

| Device | BV $V_{\text {DSS }}$ | $\mathbf{R}_{\text {DS(on) MAX }}$ | $\mathbf{I}_{\mathrm{D} \text { MAX }}$ <br> $@ T_{\mathrm{A}}=\mathbf{+ 2 5}{ }^{\circ} \mathbf{C}$ |
| :---: | :---: | :---: | :---: |
| Q1 |  | $0.45 \Omega @ \mathrm{~V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | 0.75 A |
|  |  | $0.6 \Omega @ \mathrm{~V}_{\mathrm{GS}}=2.5 \mathrm{~V}$ | 0.65 A |
| Q2 | $-20 \mathrm{~V}$ | $0.75 \Omega @ \mathrm{~V}_{\mathrm{GS}}=-4.5 \mathrm{~V}$ | -0.6 A |
|  |  | -0.5 A |  |

## Description

This new generation MOSFET is designed to minimize on-state resistance ( $\mathrm{R}_{\mathrm{DS}(o n)}$ ), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

## Applications

- Battery-Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Power Supply Converter Circuits


## Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD-Protected
- Totally Lead-Free \& Fully RoHS Compliant (Notes 1 \& 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/


## Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 e3
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)



## Ordering Information (Note 4)

| Part Number | Case | Packaging |
| :---: | :---: | :---: |
| DMC2710UDW-7 | SOT363 | $3000 /$ Tape \& Reel |
| DMC2710UDW-13 | SOT363 | $10000 /$ Tape \& Reel |

Notes: $\quad$ 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2 ) \& 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain $<900 \mathrm{ppm}$ bromine, $<900 \mathrm{ppm}$ chlorine ( $<1500 \mathrm{ppm}$ total $\mathrm{Br}+\mathrm{Cl}$ ) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## Marking Information



HX7 = Product Type Marking Code
YM or $\mathrm{YM}=$ Date Code Marking
Y or $\bar{Y}=$ Year (ex: $I=2021$ )
$M=$ Month (ex: 9 = September)
Date Code Key

| Year | 2018 | $\ldots$ | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 | 2030 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Code | F | ...... | 1 | J | K | L | M | N | 0 | P | R | S |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

Maximum Ratings ( $@ T_{A}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic |  |  | Symbol | Q1 Value | Q2 Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Drain-Source Voltage |  |  | $V_{\text {DSS }}$ | 20 | -20 | V |
| Gate-Source Voltage |  |  | $\mathrm{V}_{\text {GSS }}$ | $\pm 6$ | $\pm 6$ | V |
| Continuous Drain Current (Note 6) <br> N-Channel: $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ <br> P-Channel: $\mathrm{V}_{\mathrm{GS}}=-4.5 \mathrm{~V}$ | Steady State | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{A}}=+70^{\circ} \mathrm{C} \end{aligned}$ | ID | $\begin{gathered} 0.75 \\ 0.6 \end{gathered}$ | $\begin{gathered} -0.6 \\ -0.47 \end{gathered}$ | A |
| Maximum Continuous Body Diode Forward Current (Note 6) |  |  | Is | 0.5 | -0.4 | A |
| Pulsed Drain Current (10 $\mu$ s Pulse, Duty Cycle = 1\%) |  |  | IDM | 5 | -2.5 | A |

Thermal Characteristics (@ $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic |  | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: | :---: |
| Total Power Dissipation (Note 5) | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 0.29 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $\mathrm{R}_{\theta \mathrm{JA}}$ | 433 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Total Power Dissipation (Note 6) | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 0.38 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | $\mathrm{R}_{\theta J \mathrm{JA}}$ | 325 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\mathrm{STG}}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |  |

Electrical Characteristics N-CHANNEL-Q1 (@ $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSS }}$ | 20 | - | - | V | $\mathrm{V}_{G S}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current @ $\mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}$ | IdSs | - | - | 100 | nA | $\mathrm{V}_{\mathrm{DS}}=20 \mathrm{~V}, \mathrm{~V}_{G S}=0 \mathrm{~V}$ |
| Gate-Source Leakage | Igss | - | - | $\pm 1.0$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{GS}}= \pm 4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | 0.5 | - | 1.0 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ |
| Static Drain-Source On-Resistance | RDS(on) | - | 0.18 | 0.45 | $\Omega$ | $\mathrm{V}_{G S}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=600 \mathrm{~mA}$ |
|  |  |  | 0.21 | 0.6 |  | $\mathrm{V}_{G S}=2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=500 \mathrm{~mA}$ |
|  |  |  | 0.26 | 0.75 |  | $\mathrm{V}_{G S}=1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=350 \mathrm{~mA}$ |
| Diode Forward Voltage (Note 7) | $\mathrm{V}_{\text {SD }}$ | - | 0.7 | 1.2 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=150 \mathrm{~mA}$ |
| DYNAMIC CHARACTERISTICS (Note 8) |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | - | 42 | - | pF | $\begin{aligned} & V_{D S}=16 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \\ & \mathrm{f}=1.0 \mathrm{MHz} \end{aligned}$ |
| Output Capacitance | Coss | - | 13 | - | pF |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ | - | 6.5 | - | pF |  |
| Total Gate Charge | $\mathrm{Q}_{\mathrm{g}}$ | - | 0.6 | - | nC | $\begin{aligned} & V_{G S}=4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=10 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{D}}=250 \mathrm{~mA} \end{aligned}$ |
| Gate-Source Charge | $\mathrm{Qgs}^{\text {s }}$ | - | 0.1 | - | nC |  |
| Gate-Drain Charge | $\mathrm{Q}_{\mathrm{gd}}$ | - | 0.1 | - | nC |  |
| Turn-On Delay Time | $\mathrm{t}_{\mathrm{D} \text { (on) }}$ | - | 4.9 | - | ns | $\begin{aligned} & V_{D D}=10 \mathrm{~V}, \mathrm{~V}_{G S}=4.5 \mathrm{~V}, \\ & R_{L}=47 \Omega, R_{g}=10 \Omega \\ & I_{D}=200 \mathrm{~mA} \end{aligned}$ |
| Turn-On Rise Time | $\mathrm{t}_{\mathrm{R}}$ | - | 3.1 | - | ns |  |
| Turn-Off Delay Time | $t_{\text {( } \text { (fff }}$ | - | 386 | - | ns |  |
| Turn-Off Fall Time | $\mathrm{t}_{\mathrm{F}}$ | - | 174 | - | ns |  |
| Reverse Recovery Time | trR | - | 88 | - | ns | $\mathrm{I}_{\mathrm{F}}=1 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |
| Reverse Recovery Charge | QRR | - | 29 | - | nC |  |

Notes: 5. Device mounted on FR-4 substrate PC board, 2 oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2 oz copper, with 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.

Electrical Characteristics P-CHANNEL-Q2 (@ $T_{A}=+25^{\circ} \mathrm{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | BV ${ }_{\text {DSs }}$ | -20 | - | - | V | $V_{G S}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Zero Gate Voltage Drain Current @ $\mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}$ | IDSS | - | - | -100 | nA | $V_{D S}=-20 \mathrm{~V}, \mathrm{~V}_{G S}=0 \mathrm{~V}$ |
| Gate-Source Leakage | Igss | - | - | $\pm 2.0$ | $\mu \mathrm{A}$ | $\mathrm{V}_{G S}= \pm 4.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| ON CHARACTERISTICS (Note 7) |  |  |  |  |  |  |
| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | -0.5 | - | -1.0 | V | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{G S}, \mathrm{I}_{\mathrm{D}}=-250 \mu \mathrm{~A}$ |
| Static Drain-Source On-Resistance | RDS(on) | - | 0.48 | 0.75 | $\Omega$ | $V_{G S}=-4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-430 \mathrm{~mA}$ |
|  |  |  | 0.6 | 1.05 |  | $\mathrm{V}_{G S}=-2.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-300 \mathrm{~mA}$ |
|  |  |  | 0.76 | 1.5 |  | $\mathrm{V}_{G S}=-1.8 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-150 \mathrm{~mA}$ |
| Diode Forward Voltage (Note 7) | $\mathrm{V}_{\text {SD }}$ | - | -0.7 | -1.2 | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}$ S $=-150 \mathrm{~mA}$ |
| DYNAMIC CHARACTERISTICS (Note 8) |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | - | 49 | - | pF | $\begin{aligned} & V_{D S}=-16 V, V_{G S}=0 V, \\ & f=1.0 \mathrm{MHz} \end{aligned}$ |
| Output Capacitance | Coss | - | 12 | - | pF |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ | - | 3.4 | - | pF |  |
| Total Gate Charge | $\mathrm{Q}_{\mathrm{g}}$ | - | 0.7 | - | nC | $\begin{aligned} & V_{G S}=-4.5 \mathrm{~V}, V_{D S}=-10 \mathrm{~V}, \\ & I_{D}=-250 \mathrm{~mA} \end{aligned}$ |
| Gate-Source Charge | $\mathrm{Q}_{\mathrm{gs}}$ | - | 0.1 | - | nC |  |
| Gate-Drain Charge | $\mathrm{Q}_{\mathrm{gd}}$ | - | 0.1 | - | nC |  |
| Turn-On Delay Time | $t_{\text {d(on) }}$ | - | 16 | - | ns | $\begin{aligned} & V_{D S}=-10 \mathrm{~V}, \mathrm{~V}_{G S}=-4.5 \mathrm{~V}, \\ & R_{g}=10 \Omega, R_{L}=47 \Omega \\ & I_{D}=-200 \mathrm{~mA} \end{aligned}$ |
| Turn-On Rise Time | $\mathrm{t}_{\mathrm{R}}$ | - | 15 | - | ns |  |
| Turn-Off Delay Time | $t_{\text {D(off) }}$ | - | 213 | - | ns |  |
| Turn-Off Fall Time | $\mathrm{t}_{\mathrm{F}}$ | - | 89 | - | ns |  |
| Reverse Recovery Time | trR | - | 10.5 | - | ns | $\mathrm{IF}=1 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |
| Reverse Recovery Charge | QRR | - | 1.8 | - | nC |  |

Notes: 7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.

DMC2710UDW

## Typical Characteristics - N-CHANNEL




Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltace


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature


Figure 2. Typical Transfer Characteristic


Figure 4. Typical Transfer Characteristic


Figure 6. On-Resistance Variation with Junction
Temperature

## Typical Characteristics - N-CHANNEL (continued)



Figure 7. On-Resistance Variation with Junction Temperature


Figure 9. Diode Forward Voltage vs. Current


Figure 11. Gate Charge


Figure 8. Gate Threshold Variation vs. Junction Temperature


Figure 10. Typical Junction Capacitance

$\mathrm{V}_{\mathrm{DS}}$, DRAIN-SOURCE VOLTAGE (V)
Figure 12. SOA, Safe Operation Area

## Typical Characteristics - P-CHANNEL




Figure 15. Typical On-Resistance vs. Drain Current and Gate Voltage


Figure 17. Typical On-Resistance vs. Drain Current and Temperature


Figure 14. Typical Transfer Characteristic

$\mathrm{V}_{\mathrm{GS}}$, GATE-SOURCE VOLTAGE (V)
Figure 16. Typical Transfer Characteristic


Figure 18. On-Resistance Variation with Temperature

## Typical Characteristics - P-CHANNEL (continued)



Figure 19. On-Resistance Variation with Temperature


Figure 21. Diode Forward Voltage vs. Current


Figure 23. Gate Charge


Figure 20. Gate Threshold Variation vs.
JunctionTemperature


Figure 22. Typical Junction Capacitance



Figure 25. Transient Thermal Resistance

DMC2710UDW

## Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.
SOT363



| SOT363 |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A1 | 0.00 | 0.10 | 0.05 |
| A2 | 0.90 | 1.00 | 0.95 |
| b | 0.10 | 0.30 | 0.25 |
| c | 0.10 | 0.22 | 0.11 |
| D | 1.80 | 2.20 | 2.15 |
| E | 2.00 | 2.20 | 2.10 |
| E1 | 1.15 | 1.35 | 1.30 |
| e | 0.650 BSC |  |  |
| F | 0.40 | 0.45 | 0.425 |
| L | 0.25 | 0.40 | 0.30 |
| a | $0^{\circ}$ | $8^{\circ}$ | -- |
| All Dimensions in $\mathbf{~ m m}$ |  |  |  |
|  |  |  |  |

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.
SOT363


| Dimensions | Value <br> (in $\mathbf{~ m m}$ ) |
| :---: | :---: |
| $\mathbf{C}$ | 0.650 |
| $\mathbf{G}$ | 1.300 |
| $\mathbf{X}$ | 0.420 |
| $\mathbf{Y}$ | 0.600 |
| $\mathbf{Y 1}$ | 2.500 |

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